

#### 20V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> max	Package	I <sub>D</sub> T <sub>A</sub> = +25°C			
20V	25mΩ @ V <sub>GS</sub> = 4.5V	SO-8	5.8A			
200	35mΩ @ V <sub>GS</sub> = 2.5V	30-8	4.8A			

### Description

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

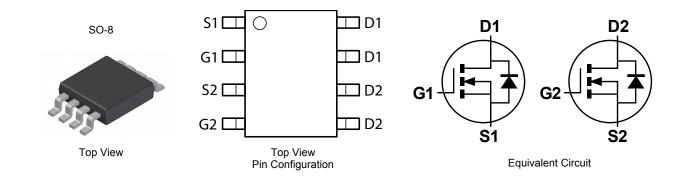
- DC-DC Converters
- Power Management Functions
- Backlighting

#### Features

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (approximate)



### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2029USD-13	SO-8	2,500/Tape & Reel

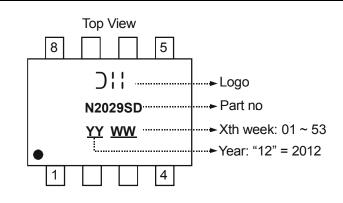
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

## **Marking Information**





# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	5.8 4.7	А
Continuous Drain Current (Note 6) $V_{GS}$ = 4.5V	t < 10s T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C		I <sub>D</sub>	6.9 5.7	А
Maximum Body Diode Forward Current (Note 6)	ls	2.1	А		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I <sub>DM</sub>	30	А
Avalanche Current (Note 7) L = 0.1mH			I <sub>AS</sub>	15	А
Avalanche Energy (Note 7) L = 0.1mH			E <sub>AS</sub>	11.2	mJ

#### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Bower Dissinction (Note E)	T <sub>A</sub> = +25°C	Pο	1.2	W
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	PD	0.7	
Thermal Desistance Junction to Ambient (Note E)	Steady state	Rθ.IA	115	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	ROJA	70	
Total Dower Dissinction (Note 6)	T <sub>A</sub> = +25°C	C	1.4	W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +70°C	PD	0.9	
Thermal Desistance Junction to Ambient (Note 6)	Steady state	D	95	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s	$R_{\theta JA}$	60	
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	14.5		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		—	1	μA	$V_{DS} = 16V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>		—	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.6	_	1.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance			14	25	mΩ	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6.5A	
	R <sub>DS(ON)</sub>	—	19	35	11152	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 5.4A	
Forward Transfer Admittance	Y <sub>fs</sub>		10	_	S	$V_{DS} = 5V, I_D = 6.5A$	
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.3A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1171	_		V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V f = 1.0MHz	
Output Capacitance	C <sub>oss</sub>	—	133	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>		110	_			
Gate Resistance	R <sub>G</sub>		1.2	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg		10.4	_			
Total Gate Charge (V <sub>GS</sub> = 8V)	Qg		18.6	_	nC	V <sub>DS</sub> = 10V, I <sub>D</sub> = 3A	
Gate-Source Charge	Q <sub>gs</sub>		1.9	_	no		
Gate-Drain Charge	Q <sub>gd</sub>		2.3	_			
Turn-On Delay Time	t <sub>D(on)</sub>	—	16.5	_			
Turn-On Rise Time	tr	_	33.3		nS	$V_{GS}$ = 4.5V, $V_{DD}$ = 10V, $R_{GEN}$ = 6 $\Omega$ , I <sub>D</sub> = 1A	
Turn-Off Delay Time	t <sub>D(off)</sub>	—	119.3	_	115		
Turn-Off Fall Time	t <sub>f</sub>	—	53.5				
Body Diode Reverse Recovery Time	trr		7.5		nS	I <sub>S</sub> = 6.5A, dI/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Qrr	_	2.0		nC	I <sub>S</sub> = 6.5A, dI/dt = 100A/µs	

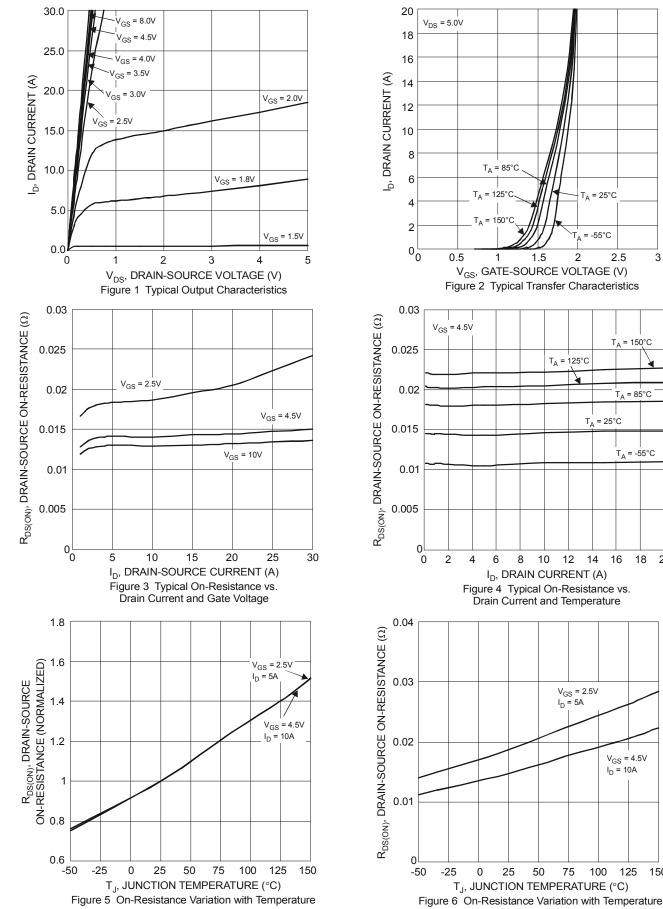
Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

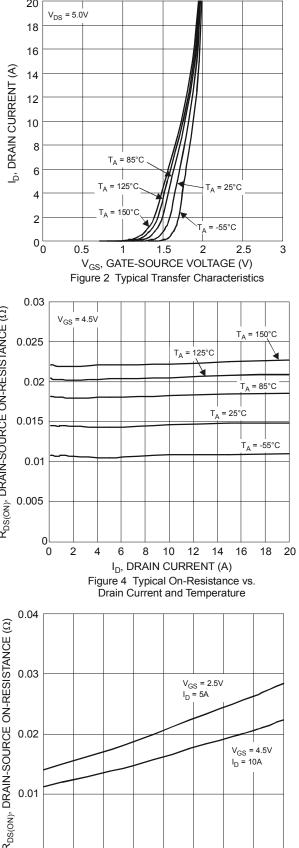
 $T_{JRR}$  and  $E_{AR}$  rating are based on low frequency and duty cycles to keep  $T_{J}$  = +25°C 8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

Notes:







25

50

T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

0

-25

75

100

125

DMN2029USD Document number: DS36127 Rev. 3 - 2

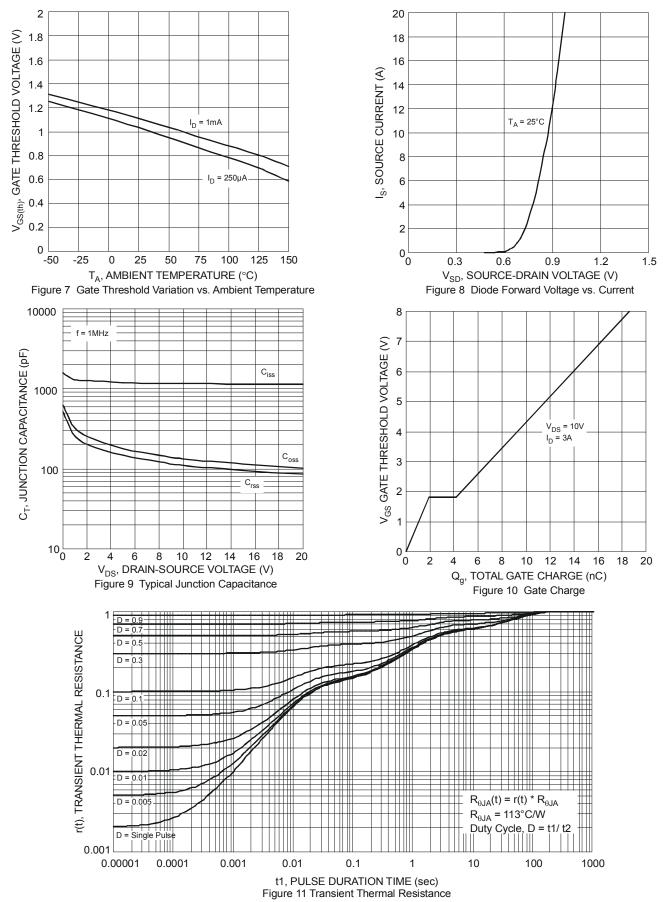
3 of 6 www.diodes.com

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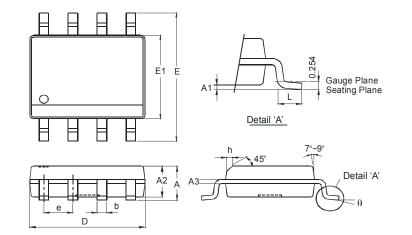
## DMN2029USD





## Package Outline Dimensions

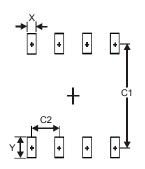
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27 Typ				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Di	All Dimensions in mm				

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27



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